

0.01 GHz to 10 GHz, GaAs, pHEMT, MMIC, Low Noise Amplifier

Data Sheet HMC8410

FEATURES

Low noise figure: 1.1 dB typical High gain: 19.5 dB typical

High output third-order intercept (IP3): 33 dBm typical

6-lead, 2 mm × 2 mm LFCSP package

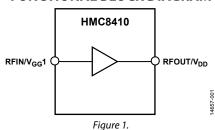
APPLICATIONS

Software defined radios Electronics warfare Radar applications

GENERAL DESCRIPTION

The HMC8410 is a gallium arsenide (GaAs), monolithic microwave integrated circuit (MMIC), pseudomorphic high electron mobility transistor (pHEMT), low noise wideband amplifier that operates from 0.01 GHz to 10 GHz. The HMC8410 provides a typical gain of 19.5 dB, a 1.1 dB typical noise figure, and a typical output IP3 of 33 dBm, requiring only 65 mA from a 5 V supply voltage. The saturated output power (Psat) of up to 22.5 dBm enables the low noise amplifier (LNA) to function as a local oscillator (LO) driver for many of Analog Devices, Inc., balanced, I/Q or image rejection mixers.

FUNCTIONAL BLOCK DIAGRAM



The HMC8410 also features inputs/outputs (I/Os) that are internally matched to 50 Ω , making it ideal for surface-mounted technology (SMT)-based, high capacity microwave radio applications.

The HMC8410 is housed in a RoHS-compliant, 2 mm \times 2 mm, LFCSP package.

Multifunction pin names may be referenced by their relevant function only.

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HMC8410* Product Page Quick Links

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Comparable Parts

View a parametric search of comparable parts

Evaluation Kits

• HMC8410 Evaluation Board

Documentation <a>□

Application Notes

 AN-1363: Meeting Biasing Requirements of Externally Biased RF/Microwave Amplifiers with Active Bias Controllers

Data Sheet

• HMC8410: 0.01 GHz to 10 GHz, GaAs, pHEMT, MMIC, Low Noise Amplifier Data Sheet

Tools and Simulations

• HMC8410 S-Parameters

Design Resources -

- HMC8410 Material Declaration
- PCN-PDN Information
- · Quality And Reliability
- · Symbols and Footprints

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REVISION HISTORY

7/2016—Revision 0: Initial Version

ELECTRICAL SPECIFICATIONS

0.01 GHz TO 3 GHz FREQUENCY RANGE

 T_{A} = 25°C, V_{DD} = 5 V, and I_{DQ} = 65 mA, unless otherwise noted.

Table 1.

Parameter	Symbol	Min	Тур	Max	Unit	Test Conditions/Comments
FREQUENCY RANGE		0.01		3	GHz	
GAIN		17.5	19.5		dB	
Gain Variation Over Temperature			0.01		dB/°C	
NOISE FIGURE			1.1	1.6	dB	
RETURN LOSS						
Input			15		dB	
Output			24		dB	
OUTPUT						
Output Power for 1 dB Compression	P1dB	19.0	21.0		dBm	
Saturated Output Power	P _{SAT}		22.5		dBm	
Output Third-Order Intercept	IP3		33		dBm	
SUPPLY CURRENT	I _{DQ}		65	80	mA	Adjust V _{GG1} to achieve I _{DQ} = 65 mA typical
SUPPLY VOLTAGE	V_{DD}	2	5	6	V	

3 GHz TO 8 GHz FREQUENCY RANGE

 T_{A} = 25°C, V_{DD} = 5 V, and I_{DQ} = 65 mA, unless otherwise noted.

Table 2.

Davamentor	Cymbal	Min	Tree	Max	Unit	Test Conditions/Comments
Parameter	Symbol	Min	Тур	iviax	Unit	rest Conditions/Comments
FREQUENCY RANGE		3		8	GHz	
GAIN		15.5	18		dB	
Gain Variation Over Temperature			0.01		dB/°C	
NOISE FIGURE			1.4	1.9	dB	
RETURN LOSS						
Input			12		dB	
Output			12		dB	
OUTPUT						
Output Power for 1 dB Compression	P1dB	18.0	21.0		dBm	
Saturated Output Power	P_{SAT}		22.5		dBm	
Output Third-Order Intercept	IP3		31.5		dBm	
SUPPLY CURRENT	I _{DQ}		65	80	mA	Adjust V_{GG1} to achieve $I_{DQ} = 65$ mA typical
SUPPLY VOLTAGE	V_{DD}	2	5	6	V	

8 GHz TO 10 GHz FREQUENCY RANGE

 T_{A} = 25°C, $V_{\rm DD}$ = 5 V, and $I_{\rm DQ}$ = 65 mA, unless otherwise noted.

Table 3.

Parameter	Symbol	Min	Тур	Max	Unit	Test Conditions/Comments
FREQUENCY RANGE		8		10	GHz	
GAIN		13	16		dB	
Gain Variation Over Temperature			0.01		dB/°C	
NOISE FIGURE			1.7	2.2	dB	
RETURN LOSS						
Input			6		dB	
Output			10		dB	
OUTPUT						
Output Power for 1 dB Compression	P1dB	17.5	19.5		dBm	
Saturated Output Power	P _{SAT}		21.5		dBm	
Output Third-Order Intercept	IP3		33		dBm	
SUPPLY CURRENT	I_{DQ}		65	80	mA	Adjust V _{GG1} to achieve I _{DQ} = 65 mA typical
SUPPLY VOLTAGE	V _{DD}	2	5	6	V	

ABSOLUTE MAXIMUM RATINGS

Table 4.

14010 1.	
Parameter ¹	Rating
Drain Bias Voltage (V _{DD})	7 V dc
Radio Frequency (RF) Input Power (RFIN)	20 dBm
Continuous Power Dissipation (P _{DISS}), T = 85°C (Derate 1.48 mW/°C above 85°C)	1.3 W
Channel Temperature	175°C
Storage Temperature Range	−65°C to +150°C
Operating Temperature Range	-40°C to +85°C
Thermal Resistance (Channel to Ground Paddle)	67.73°C/W
Maximum Peak Reflow Temperature (MSL3) ²	260°C
ESD Sensitivity	
Human Body Model (HBM)	Class1B Passed 500 V

¹ When referring to a single function of a multifunction pin in the parameters, only the portion of the pin name that is relevant to the specification is listed. For the full pin names of multifunction pins, refer to the Pin Configuration and Function Descriptions section.

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

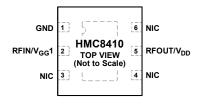
ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

² See the Ordering Guide section for more information.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



- NOTES
 1. NIC = NOT INTERNALLY CONNECTED. THIS PIN MUST BE CONNECTED TO THE RF/DC GROUND.
 20 EXPOSED PAD. THE EXPOSED PAD MUST BE CONNECTED TO RF/DC GROUND.
 - Figure 2. Pin Configuration

Table 5. Pin Function Descriptions

Pin No.	Mnemonic	Description
1	GND	Ground. This pin must be connected to the RF/dc ground. See Figure 3 for the interface schematic.
2	RFIN/V _{GG} 1	RF Input (RFIN). This pin is ac-coupled and matched to 50 Ω . See Figure 4 for the interface schematic.
		Gate Bias of the Amplifier (V_{GG} 1). This pin is ac-coupled and matched to 50 Ω . See Figure 4 for the interface schematic.
3, 4, 6	NIC	Not Internally Connected. This pin must be connected to the RF/dc ground.
5	RFOUT/V _{DD}	RF Output (RFOUT). This pin is ac-coupled and matched to 50 Ω . See Figure 5 for the interface schematic.
		Drain Bias for Amplifier (V_{DD}). This pin is ac-coupled and matched to 50 Ω . See Figure 5 for the interface schematic.
	EPAD	Exposed Pad. The exposed pad must be connected to RF/dc ground.

INTERFACE SCHEMATICS



Figure 3. GND Interface Schematic

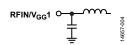


Figure 4. RFIN/V_{GG}1 Interface Schematic



Figure 5. RFOUT/ V_{DD} Interface Schematic

TYPICAL PERFORMANCE CHARACTERISTICS

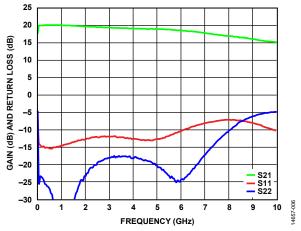


Figure 6. Gain and Return Loss vs. Frequency

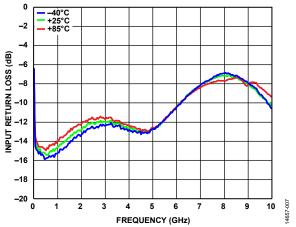


Figure 7. Input Return Loss vs. Frequency for Various Temperatures

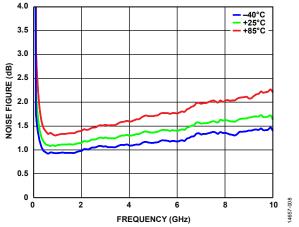


Figure 8. Noise Figure vs. Frequency for Various Temperatures

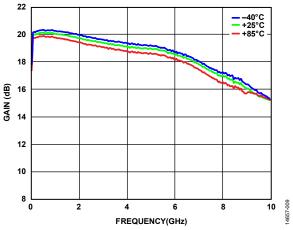


Figure 9. Gain vs. Frequency for Various Temperatures

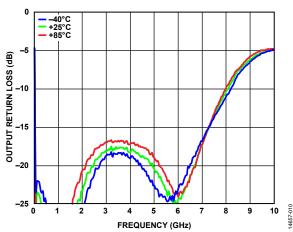


Figure 10. Output Return Loss vs. Frequency for Various Temperatures

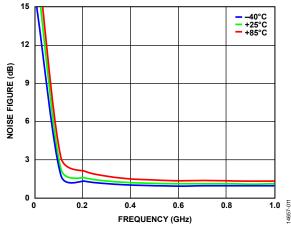


Figure 11. Noise Figure vs. Frequency for Various Temperatures, 10 MHz to 1 GHz

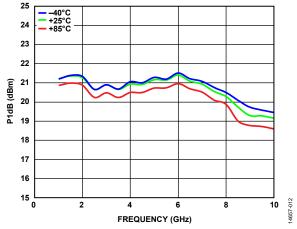


Figure 12. P1dB vs. Frequency for Various Temperatures

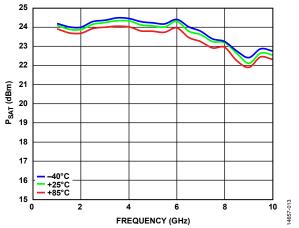


Figure 13. P_{SAT} vs. Frequency for Various Temperatures

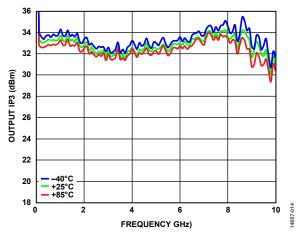


Figure 14. Output IP3 vs. Frequency for Various Temperatures, Output Power (P_{OUT})/Tone = 5 dBm

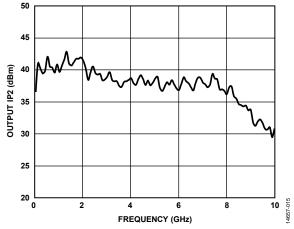


Figure 15. Output IP2 vs. Frequency at P_{OUT} /Tone = 5 dBm

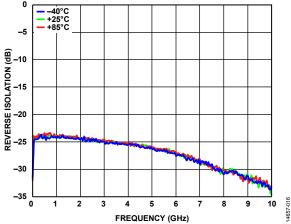


Figure 16. Reverse Isolation vs. Frequency for Various Temperatures

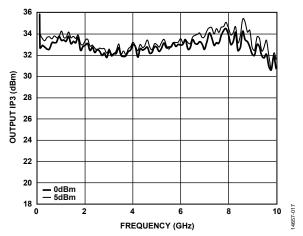


Figure 17. Output IP3 vs. Frequency for Various P_{OUT}/Tone

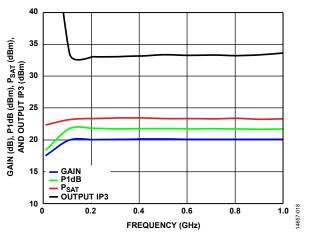


Figure 18. Gain, P1dB, P_{SAT}, and Output IP3 vs. Frequency

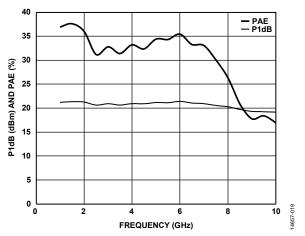


Figure 19. P1dB and Power Added Efficiency (PAE) vs. Frequency

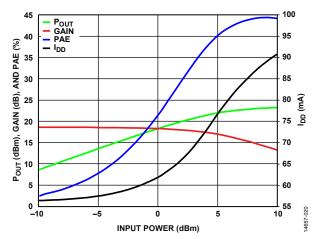


Figure 20. P_{OUT}, Gain, PAE, and Supply Current with RF Applied (I_{DD}) vs. Input Power (Performance Below 100 MHz Is Limited by the Bias Network and Does Not Reflect True Device Performance)

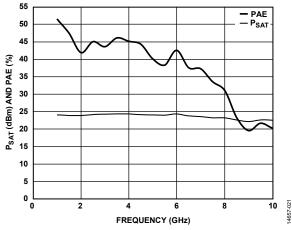


Figure 21. Psat and PAE vs. Frequency

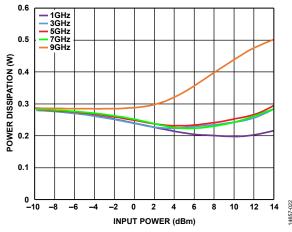


Figure 22. Power Dissipation at 85°C vs. Input Power at Various Frequencies

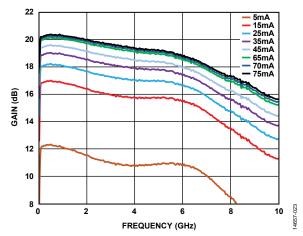


Figure 23. Gain vs. Frequency for Various Supply Currents, $V_{DD} = 5 V$

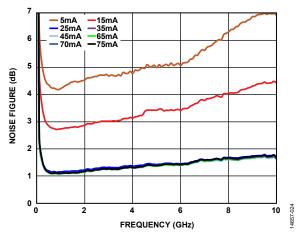


Figure 24. Noise Figure vs. Frequency for Various Supply Currents (I_{DQ}), $V_{DD} = 5 \text{ V}$

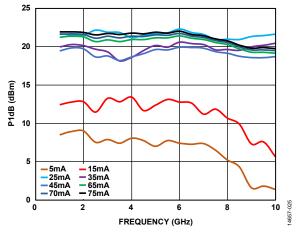


Figure 25. P1dB vs. Frequency for Various Supply Currents (I_{DQ}), $V_{DD} = 5 V$

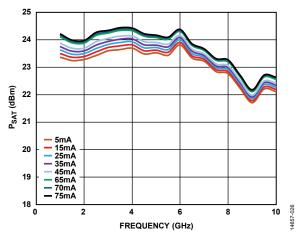


Figure 26. P_{SAT} vs. Frequency for Various Supply Currents (I_{DQ}), $V_{DD} = 5 V$

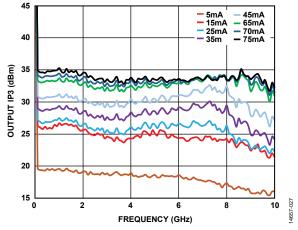


Figure 27. Output IP3 vs. Frequency for Various Supply Currents (I_{DQ}), $P_{OUT}/Tone = 5 dBm$, $V_{DD} = 5 V$

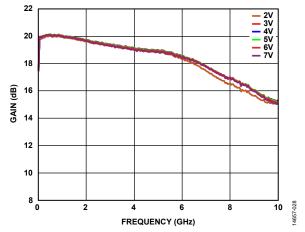


Figure 28. Gain vs. Frequency for Various Supply Voltages, $I_{DQ} = 65 \text{ mA}$

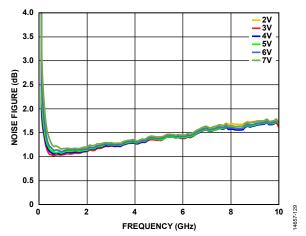


Figure 29. Noise Figure vs. Frequency for Various Supply Voltages, $I_{DQ} = 65 \text{ mA}$

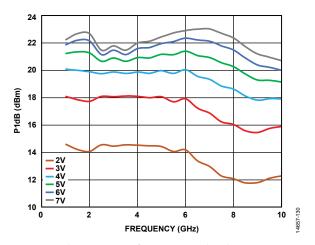


Figure 30. P1dB vs. Frequency for Various Supply Voltages, $I_{DQ} = 65 \text{ mA}$

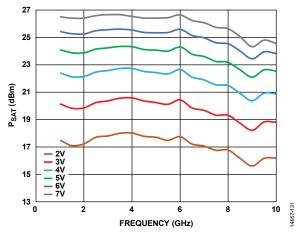


Figure 31. P_{SAT} vs. Frequency for Various Supply Voltages, $I_{DQ} = 65 \text{ mA}$

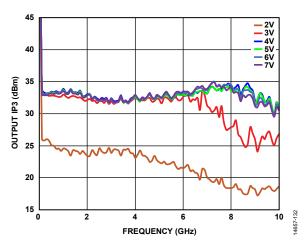


Figure 32. Output IP3 vs. Frequency for Various Supply Voltages, $P_{OUT}/Tone = 5 dBm$

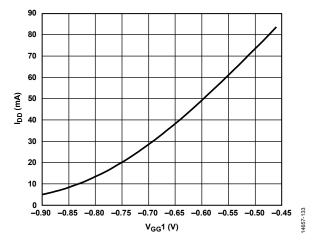


Figure 33. Supply Current with RF Applied (I_{DD}) vs. V_{GG} 1, V_{DD} = 5 V, Representative of a Typical Device

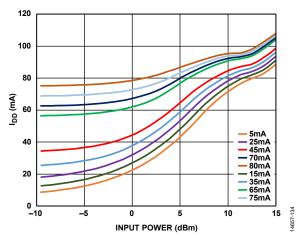


Figure 34. Supply Current with RF Applied (I_{DD}) vs. Input Power for Various Supply Currents (I_{DO}), $V_{DD} = 5 V$

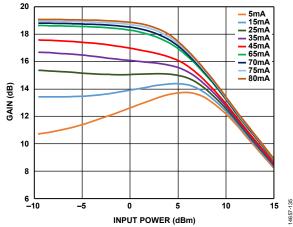


Figure 35. Gain vs. Input Power for Various Supply Currents (I_{DQ}) at 5 GHz, $V_{DD} = 5~V$

THEORY OF OPERATION

The HMC8410 is a gallium arsenide (GaAs), monolithic microwave integrated circuit (MMIC), pseudomorphic (pHEMT), low noise wideband amplifier.

The cascode amplifier uses a fundamental cell of two field effect transistors (FETs) in series, source to drain. The basic schematic for the cascode cell is shown in Figure 36, which forms a low noise amplifier operating from 0.01 GHz to 10 GHz with excellent noise figure performance.

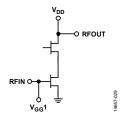


Figure 36. Basic Schematic for the Cascode Cell

The HMC8410 has single-ended input and output ports whose impedances are nominally equal to 50 Ω over the 0.01 GHz to 10 GHz frequency range. Consequently, it can directly insert into a 50 Ω system with no required impedance matching circuitry, which also means that multiple HMC8410 amplifiers can be cascaded back to back without the need for external matching circuitry.

The input and output impedances are sufficiently stable vs. variations in temperature and supply voltage that no impedance matching compensation is required.

Note that it is critical to supply very low inductance ground connections to the ground pins as well as to the backside exposed paddle to ensure stable operation.

To achieve optimal performance from the HMC8410 and prevent damage to the device, do not exceed the absolute maximum ratings.

APPLICATIONS INFORMATION

Figure 37 shows the basic connections for operating the HMC8410. AC couple the input and output of the HMC8410 with appropriately sized capacitors. DC block capacitors and RF choke inductors are supplied on the RFIN and RFOUT pins of the HMC8410 evaluation board. See Table 6 for additional information. These dc block capacitors and RF choke inductors form wideband bias tees on the input and output ports to provide both ac coupling and the necessary supply voltages to the RFIN and RFOUT pins. A 5 V dc bias is supplied to the amplifier through the choke inductor connected to the RFOUT pin, and the negative $V_{\rm GG}1$ voltage is supplied to the RFIN pin through the choke inductor.

RECOMMENDED BIAS SEQUENCING

To not damage the amplifier, follow the recommended bias sequencing.

During Power-Up

The recommended bias sequence during power-up for the HMC8410 follows:

- 1. Connect to GND.
- 2. Set $V_{GG}1$ to -2 V.
- 3. Set V_{DD} to +5 V.
- 4. Increase $V_{GG}1$ to achieve a typical supply current (I_{DQ}) = 65 mA.
- Apply the RF signal.

During Power-Down

The recommended bias sequence during power-down for the HMC8410 follows:

- 1. Turn off the RF signal.
- 2. Decrease $V_{GG}1$ to -2 V to achieve a typical $I_{DQ} = 0$ mA.
- 3. Decrease V_{DD} to 0 V.
- 4. Increase V_{GG}1 to 0 V.

The bias conditions previously listed ($V_{\rm DD}$ = 5 V and $I_{\rm DQ}$ = 65 mA) are the recommended operating points to achieve optimum performance. The data used in this data sheet was taken with the recommended bias conditions. When using the HMC8410 with different bias conditions, different performance than what is shown in the Typical Performance Characteristics section may result.

Figure 18, Figure 30, and Figure 31 show that increasing the voltage from 2 V to 7 V typically increases P1dB and P_{SAT} at the expense of power consumption with minor degradation on noise figure (NF).

TYPICAL APPLICATION CIRCUIT

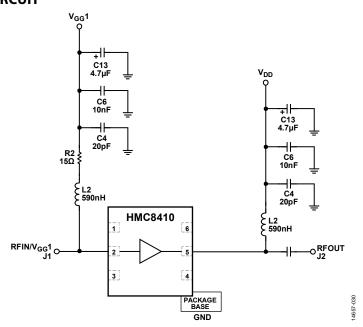


Figure 37. Typical Application Circuit

EVALUATION BOARD

The HMC8410 evaluation board is a 4-layer board fabricated using a Rogers 4350 and the best practices for high frequency RF design. The RF input and RF output traces have a 50 Ω characteristic impedance.

The HMC8410 evaluation board and populated components operate over the -40° C to $+85^{\circ}$ C ambient temperature range. For proper bias sequence, see the Applications Information section.

The HMC8410 evaluation board schematic is shown in Figure 39. A fully populated and tested evaluation printed circuit board (PCB) is available from Analog Devices, Inc., upon request (see Figure 38).

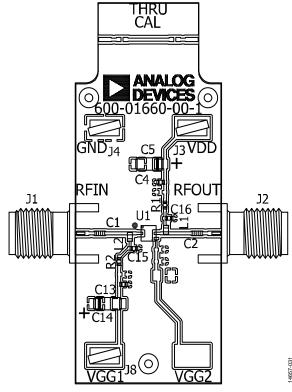


Figure 38. HMC8410 Evaluation PCB

EVALUATION BOARD SCHEMATIC

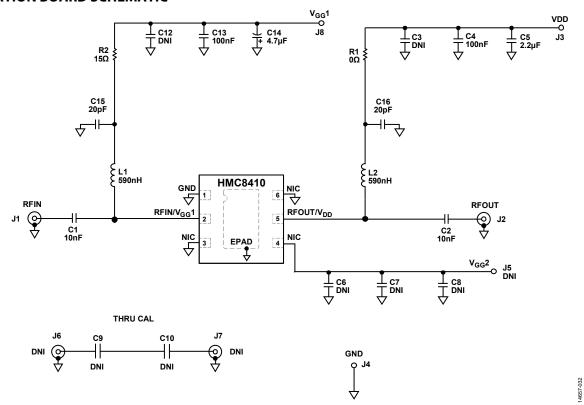


Figure 39. HMC8410 Evaluation Board Schematic

Table 6. Bill of Materials for Evaluation PCB EV1HMC8410LP2F

Item	Description
J1, J2	PCB mount SMA RF connectors, SRI 21-146-1000-01
J3, J4, J8	DC bias test points
C1, C2	Capacitors, broadband, 10 nF and 82 pF, 0502, 160 kHz and 40 GHz; Presidio Components MBB0502X103MLP5N8L
C3, C6 to C10, C12, J5 to J7	Do not install (DNI)
C4, C13	Capacitors, ceramic, 100 nF, 0402 package
C5	Capacitor, tantalum, 2.2 μF, Size A
C14	Capacitor, tantalum, 4.7 μF, 3216 package
C15, C16	Capacitors, ceramic, 20 pF, 0402 package
L1, L2	Inductors, 590 nH, 0402, 5%, ferrite DF, Coilcraft 0402DF-591XJRU
R1	0 Ω resistor
R2	15 Ω resistor, 0402 package
U1	Amplifier, HMC8410
Heat sink	Heat sink
PCB	600-01660-00 evaluation PCB; circuit board material: Rogers 4350

OUTLINE DIMENSIONS

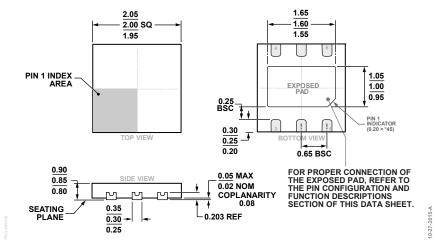


Figure 40. 6-Lead Lead Frame Chip Scale Package [LFCSP], $2 \text{ mm} \times 2 \text{ mm}$ Body and 0.85 mm Package Height (CP-6-9) Dimensions shown in millimeters

ORDERING GUIDE

Model ¹	Temperature Range	MSL Rating ²	Lead Finish	Package Description	Package Option	Branding ³
HMC8410LP2FE	−40°C to +85°C	MSL3	100% Matte Sn	6-Lead LFCSP	CP-6-9	8410
						XXXX
HMC8410LP2FETR	-40°C to +85°C	MSL3	100% Matte Sn	6-Lead LFCSP	CP-6-9	8410
						XXXX
EV1HMC8410LP2F				Evaluation PCB		

¹ The HMC8410LP2FE and HMC8410LP2FETR are RoHS Compliant Parts. ² See the Absolute Maximum Ratings section for additional information.

³ XXX is the three digit lot number.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Analog Devices Inc.:

HMC8410LP2FE EV1HMC8410LP2F HMC8410LP2FETR